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	FLH Ref. No.: 450117-04088
1022155	LEET U.S. DEPARTMENT OF COMMERCE
······································	lease record the attached original documents or copy thereof
1. Name of conveying party(ies)	2. Name and address of receiving party(ies)
Tzenka MITEVA, Gabriele NELLES, Akio YASUDA, Andreas MEISEL, Dieter NEHER	Name: SONY International (Europe) GmbH Kemperplatz 1 D-10785 Berlin GERMANY
Additional name(s) of conveying party(ies) attached? YesNo	and T
3. Nature of conveyance:	Max-Planck-Gesellschaft zur Förderung der Wissenschaften e.V. Hofgartenstrasse 8 80539 München - GERMANY
X Assignment Security Agreement Merger Change of Name Other Execution Data: August 16 August 17 August 26 August 10	Additional name(s) & address(es) attached? <u>Yes x</u> No
Execution Date: <u>August 16, August 13, August 26, August 10</u> and August 20, 2002	17.10
<ul> <li>4. Application number(s) or patent number(s):</li> <li>If this document is being filed together with the application is: <u>August 16, August 13, August 16</u></li> <li>A. Patent Application No.(s) filed</li> </ul>	h a new application, the execution date of ugust 26, August 10 and August 20, 2002
Additional numbers atta	ached? <u>Yes X</u> No
<ol> <li>Name and address of party to whom correspondence concerning document should be mailed:</li> </ol>	6. Total number of applications and patents involved
Name: WILLIAM S. FROMMER Internal Address: FROMMER LAWRENCE & HAUG LLP	7. Total fee (37 CFR 3.41)
Street Address: 745 FIFTH AVENUE	<ol> <li>B. Deposit account number:</li> <li>(Attach duplicate copy of this page if paying by deposit</li> </ol>
09/2002 TDIAZ1 00000050 10231935	account)
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Dennis M. Smid	August 30, 2002
Name of Person Signing Signa	Date Total number of pages including cover sheet, attachments, and document: 4
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# PATENT REEL: 013254 FRAME: 0760

#### ASSIGNMENT

WHERFAS, I, as below named inventors, residing at the addresses stated next to our nomes, am a sole inventor (if only one name is listed below) or a jaint inventor (if plural names are listed below) of certain new and ysoful improvements in

### ALIGNED EMISSIVE FOLYMER BLEND, FILM AND DEVICE BASED THEREON

for which upplication for Lettery Patent of the United Status of America was executed by me on the date indicated next to my nume and address;

AND WHEREAS, SONY International (Europe) GmbH, a Germon corporation, with offices at Kemperplatz 1, D-10785 Barlin, GERMANY and Max-Planck-Gapelischaft zur Förderung der Wissenschaften c.V., a German corporation, with efficed at Hofgertenatroses 0, 90539 Hünchen, GERMANY (hereinafter referred to se ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Fatent er similar legal protection which may be granted therefat in the United States and in any and all foreign countries:

NOW THEREFORD, in consideration of the sum of One Bollar (\$1,00), and other good and valuable consideration, the neeipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the antire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign therets, which may be granted for sold invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Pretection of Industrial Property. Inter-American Convention Relating to Patents, besigns and Industrial Models, and only other international agreements to which the United States of America adheres, and to any other bonefile accounts of the convention for the account to the sole and counties of and the sole of and in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to acid ASSIGNEE, as the assignee of the while right, title and interest thereto.

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASBIGNEE or its designee, as ASSIGNEE or its ducessors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries forsign thereas;

And I further agree to properly execute and deliver and without further remuneration, such necessary on desirable and lewful opports for application for forcing patents, for fitting subdivisions of said application for patent, and or, for obtaining any relates or releases of any Letters patent which may be granted for my aforesoid invention, as the ASSIGNSE thereof shall be define and propare at its own expense;

And i further agree that ASSICNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, sold invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I honeby coverant that no addignment, take, agreement or encumbrance had been or will be made or entered into which would contilet with this assignment and gain

And I hereby authorize and request my attorney(a) of record in this application to insert the serial mumber and filing date of this application in the spaces that fallows. Serial Number: \_\_\_\_\_, Filing Date: \_\_\_\_\_,

This basignment executes on the dates indicated bailow.

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TZEOKS MITEVA

Name of first or sole inventor	Execution date of U.S. Patent Application
Stuttgart. Germany	
Residence of first or sale inventor T. Miteva	16.8.02
	Date of this assignment
Gatriele NELLES	
Name of second inventor	Execution date of U.S. Patent Application
Stuttgant, Germany	
Residence of second inventor lot Ville	KI108102
Signature of second inventor	Date of this accignment
Akic YASUDA	
Nome of third inventor	Execution date of U.S. Patent Application
Stutigant, Cermany	
Residence of third inventor Hard JackAG	26/08/02
signature of third inventor	Date of this assignment /

### PATENT REEL: 013254 FRAME: 0761

Andreas	MEISEL
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Execution data of U.S. Patent Application	
nisel 0\$/10/02	
Date of this assignment-	
Execution date of U.S. Patent Application	
Date of this assignment	

# PATENT REEL: 013254 FRAME: 0762

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Andreas HEISEL

Name of fourth investor

Execution date of U.S. Patent Application

Frankfurt. Germany Residence of fourth inventor

Signature of fourth investor

Date of this assignment

Dieter NEHER

Nome of fifte fevensor

Execution date of U.S. Patant Application

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Potsdani, Germany

Resident of fifth inventor

Signature of fifth inventor

20.08.2002

and the second second

Date of this assignment